



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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BC817-16 THRU BC817-40

NPN Small Signal Transistor 310mW

Features

- Halogen free available upon request by adding suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix designates RoHS Compliant. See ordering information)
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1
- Ideally Suited for Automatic Insertion
- 150 C Junction Temperature
- For Switching and AF Amplifier Applications
- Epitaxial Planar Die Construction

Mechanical Data

- Case: SOT-23, Molded Plastic
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approx.)
- Marking: BC817-16 6A
 BC817-25 6B
 BC817-40 6C

Maximum Ratings @ 25°C Unless Otherwise Specified

Charateristic	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	45	V
Emitter-Base Voltage	V_{EBO}	5	V
Collector Current	I_C	800	mA
Peak Collector Current	I_{CM}	1000	mA
Peak Emitter Current	I_{EM}	1000	mA
Power Dissipation@ $T_s=50^\circ\text{C}$ (Note1)	P_d	310	mW
Operating & Storage Temperature	T_j, T_{STG}	-55~150	°C

Note: 1. Device mounted on Ceramic Substrate 0.7mm X 2.5cm² area

SOT-23

DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.110	.120	2.80	3.04	
B	.083	.104	2.10	2.64	
C	.047	.055	1.20	1.40	
D	.035	.041	.89	1.03	
E	.070	.081	1.78	2.05	
F	.018	.024	.45	.60	
G	.0005	.0039	.013	.100	
H	.035	.044	.89	1.12	
J	.003	.007	.085	.180	
K	.015	.020	.37	.51	

Suggested Solder Pad Layout

Electrical Characteristics @25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
DC Current Gain	Current Gain Group -16 -25 -40	100	250	—	$V_{CE} = 1.0V, I_C = 100mA$
		160	400		$V_{CE} = 1.0V, I_C = 300mA$
	Current Gain Group -16 -25 -40	250	600	—	
		60	—		
		100	—		
		170	—		
Thermal Resistance, Junction to Substrate Backside	$R_{\theta SB}$	—	323	°C/W	
Thermal Resistance, Junction to Ambient Air	$R_{\theta JA}$	—	403	°C/W	
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	0.7	V	$I_C = 500mA, I_B = 50mA$
Base-Emitter Voltage	V_{BE}	—	1.2	V	$V_{CE} = 1.0V, I_C = 300mA$
Collector-Emitter Cutoff Current	I_{CES}	—	100	nA	$V_{CE} = 45V$
		—	5.0	μA	$V_{CE} = 25V, T_J = 150°C$
Emitter-Base Cutoff Current	I_{EBO}	—	100	nA	$V_{EB} = 4.0V$
Gain Bandwidth Product	f_T	100	—	MHz	$V_{CE} = 5.0V, I_C = 10mA, f = 50MHz$
Collector-Base Capacitance	C_{CBO}	—	12	pF	$V_{CB} = 10V, f = 1.0MHz$

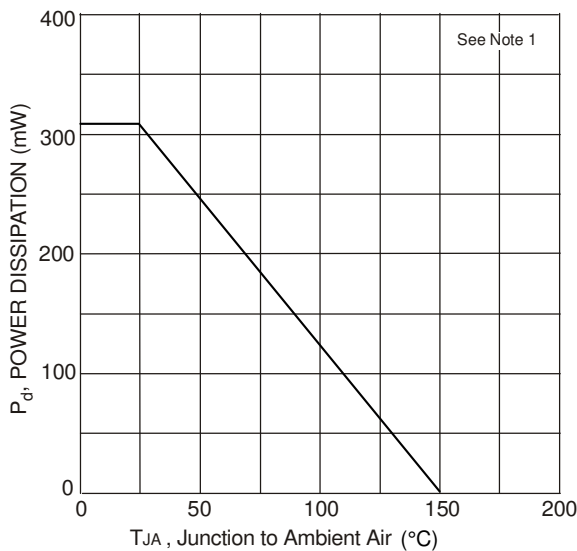


Fig. 1, Power Derating Curve

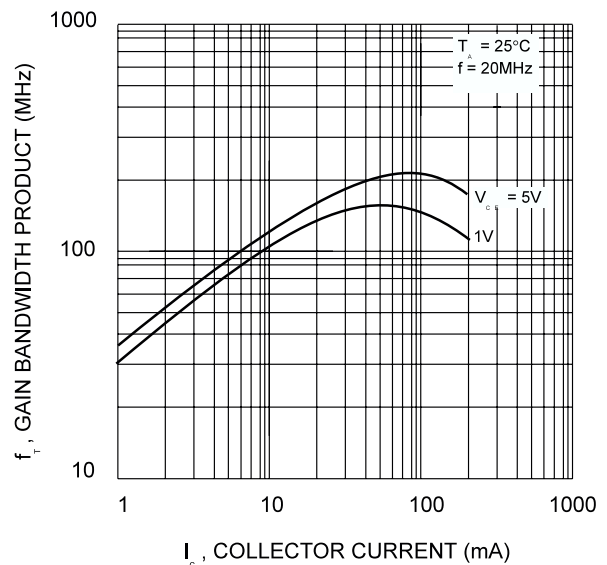


Fig. 2, Gain-Bandwidth Product vs Collector Current

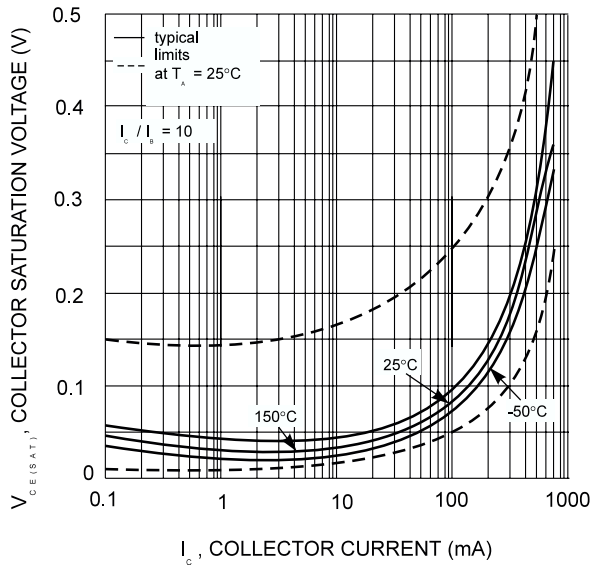


Fig. 3, Collector Sat. Voltage vs Collector Current

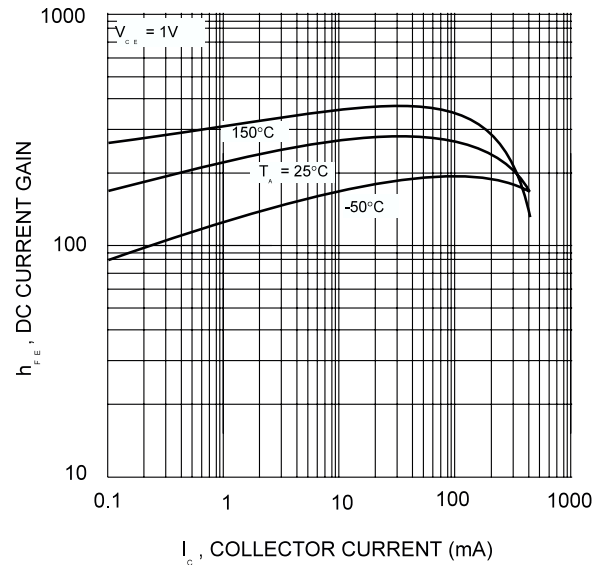


Fig. 4, DC Current Gain vs Collector Current

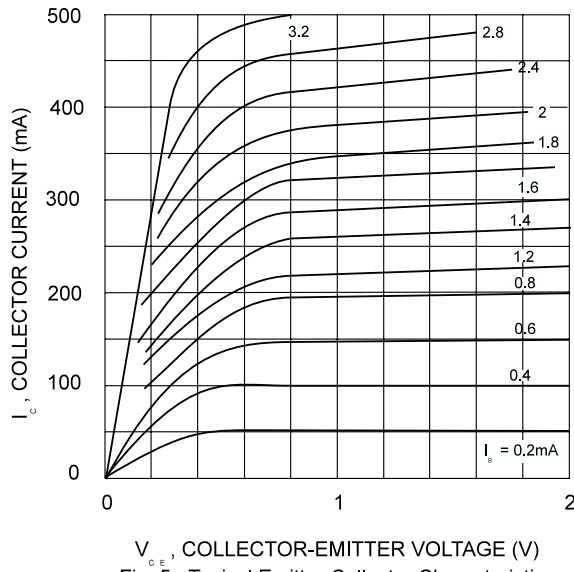


Fig. 5, Typical Emitter-Collector Characteristics

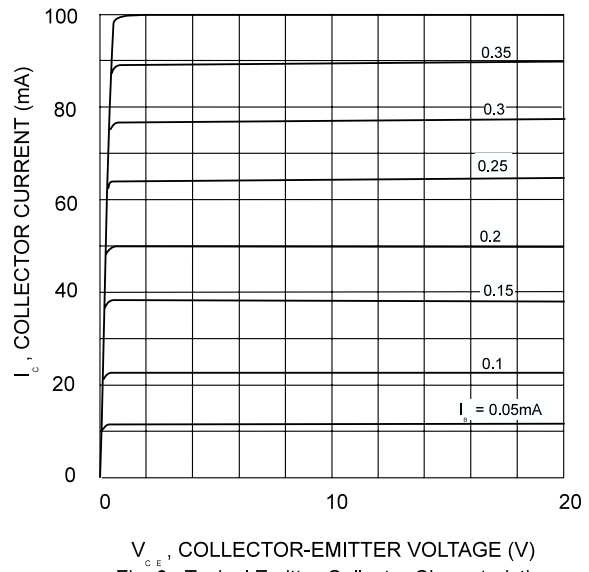


Fig. 6, Typical Emitter-Collector Characteristics



Micro Commercial Components

Ordering Information :

Device	Packing
Part Number-TP	Tape & Reel; 3 Kpcs/Reel

Note : Adding "-HF" suffix for halogen free, eg. Part Number-TP-HF

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